MOSFET – Power, N-Channel, SUPERFET III, Easy Drive

650 V, 17 A, 180 mΩ

FCMT180N65S3

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET Easy-drive series helps manage EMI issues and allows for easier design implementation.

The Power88 package is an ultra-slim surface-mount package (1 mm high) with a low profile and small footprint (8x8 mm²). SUPERFET III MOSFET in a Power88 package offers excellent switching performance due to lower parasitic source inductance and separated power and drive sources. Power88 offers Moisture Sensitivity Level 1 (MSL 1).

Features

- 700 V @ $T_J = 150 \,^{\circ}C$
- Typ $R_{DS(on)} = 152 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_g = 33 \text{ nC}$)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 305 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

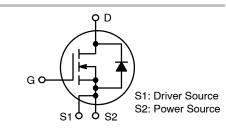
- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar
- Lighting / Charger / Adapter



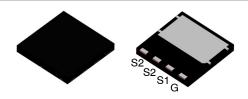
ON Semiconductor®

www.onsemi.com

V _{DSS}	R _{DS(ON)} MAX	I _D MAX
650 V	180 m Ω @ 10 V	17 A

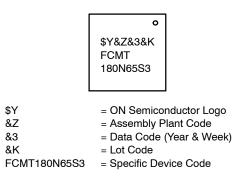


POWER MOSFET



PQFN4 8X8 2P CASE 483AP

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Param	Value	Unit	
V _{DSS}	Drain to Source Voltage		650	V
V _{GSS}	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	V
I _D	Drain Current	Continuous (T _C = 25°C)	17	А
	Continuous (T _C = 100°C)		11	
I _{DM}	Drain Current	Pulsed (Note 1)	42.5	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		80	mJ
I _{AS}	Avalanche Current (Note 2)		2.4	А
E _{AR}	Repetitive Avalanche Energy (Note 1)	Repetitive Avalanche Energy (Note 1)		mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	1
PD	Power Dissipation	(T _C = 25°C)	139	W
		Derate Above 25°C	1.11	W/°C
T _J , T _{STG}	Operating and Storage Temperature Ra	nge	-55 to +150	°C
ΤL	Maximum Lead Temperature for Solderi	ng, 1/8″ from Case for 5 s	300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. $I_{AS} = 2.4 \text{ A}$, RG = 25 Ω starting $T_J = 25^{\circ}\text{C}$ 3. $I_{SD} \le 9 \text{ A}$, di/dt $\le 200 \text{ A}/\mu\text{s}$, $V_{DD} \le 400 \text{ V}$, starting $T_J = 25^{\circ}\text{C}$

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max.	0.9	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max. (Note 4)	45	

4. Device on 1 in² pad 2 oz copper pad on 1.5 x 1.5 in. board of FR-4 material.

ORDERING INFORMATION

Part Number	Top Marking	Package	Reel Size	Tape Width	Shipping [†]
FCMT180N65S3	FCMT180N65S3	PQFN8	13"	13.3 mm	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
FF CHARA	ACTERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650			V
		V_{GS} = 0 V, I_D = 1 mA, T_J = 150°C	700			V
$\begin{array}{c} \Delta \text{BV}_{\text{DSS}} \\ /\Delta T_{\text{J}} \end{array}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, referenced to 25°C		0.64		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$			10	μA
		V_{DS} = 520 V, T_{C} = 125 °C		1.18		
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA

ON CHARACTERISTICS

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 0.39 \text{ mA}$	2.5		4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 8.5 A		152	180	mΩ
9fs	Forward Transconductance	V_{DS} = 20 V, I_{D} = 8.5 A		11		S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	1350	pF
C _{oss}	Output Capacitance		30	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	305	pF
C _{oss(er.)}	Energy Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	42	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	33	nC
Q _{gs}	Gate to Source Gate Charge	(Note 5)	8	nC
Q _{gd}	Gate to Drain "Miller" Charge]	14	nC
ESR	Equivalent Series Resistance	f = 1 MHz	0.5	Ω

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	17	ns
t _r	Rise Time	R _{GEN} = 4.7 Ω (Note 5)	16	ns
t _{d(off)}	Turn-Off Delay Time		43	ns
t _f	Fall Time		6	ns

SOURCE-DRAIN DIODE CHARACTERISTICS

۱ _S	Maximum Continuous Source to Drain Diode Forward Current			17	А
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current			42.5	А
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 8.5 \text{ A}$		1.2	V
t _{rr}	Reverse Recovery Time	$V_{DD} = 400 \text{ V}, \text{I}_{SD} = 8.5 \text{ A},$	290		ns
Q _{rr}	Reverse Recovery Charge	di _F /dt = 100 A/µs	3.9		μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

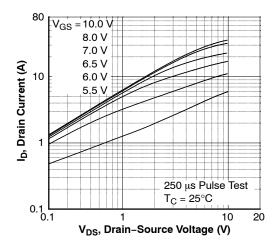
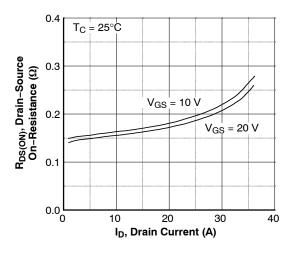
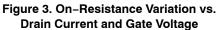
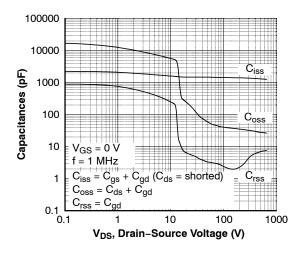


Figure 1. On–Region Characteristics









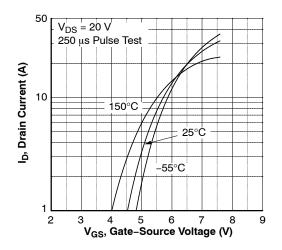
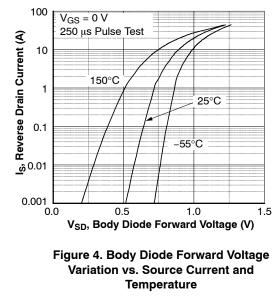
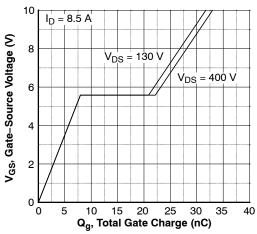


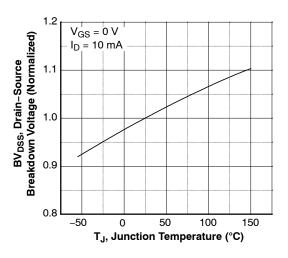
Figure 2. Transfer Characteristics







TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





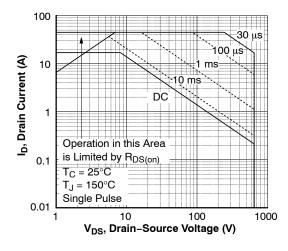


Figure 9. Maximum Safe Operating Area

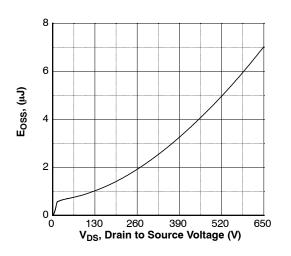


Figure 11. E_{OSS} vs. Drain to Source Voltage

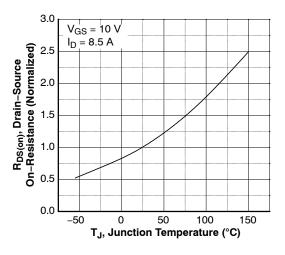


Figure 8. On–Resistance Variation vs. Temperature

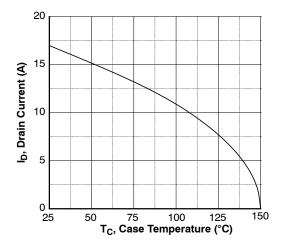


Figure 10. Maximum Drain Current vs. Case Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

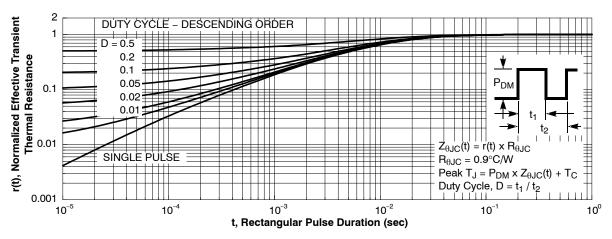


Figure 12. Transient Thermal Response Curve

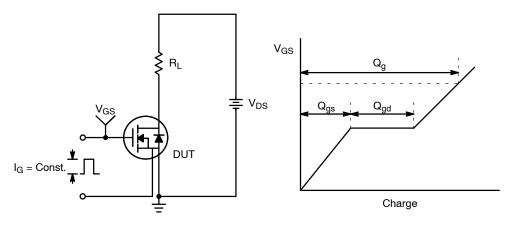


Figure 13. Gate Charge Test Circuit & Waveform

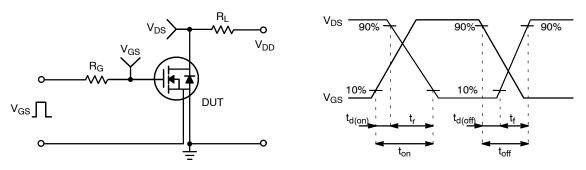
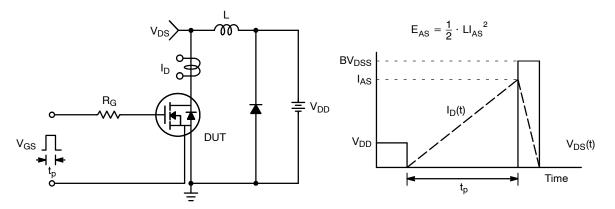


Figure 14. Resistive Switching Test Circuit & Waveforms





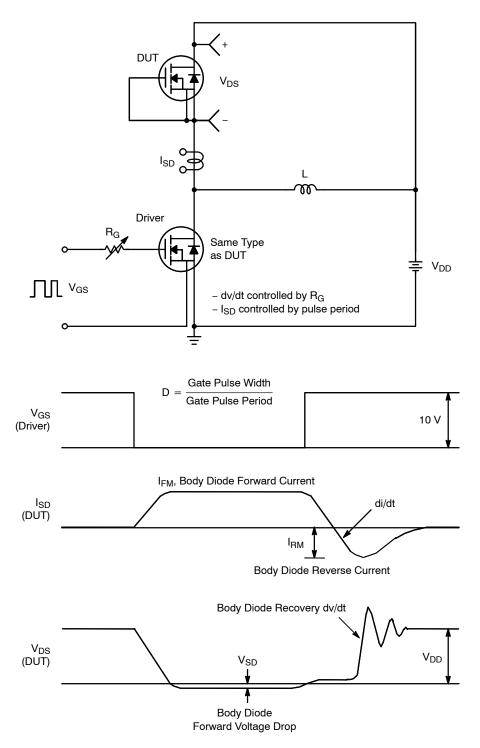
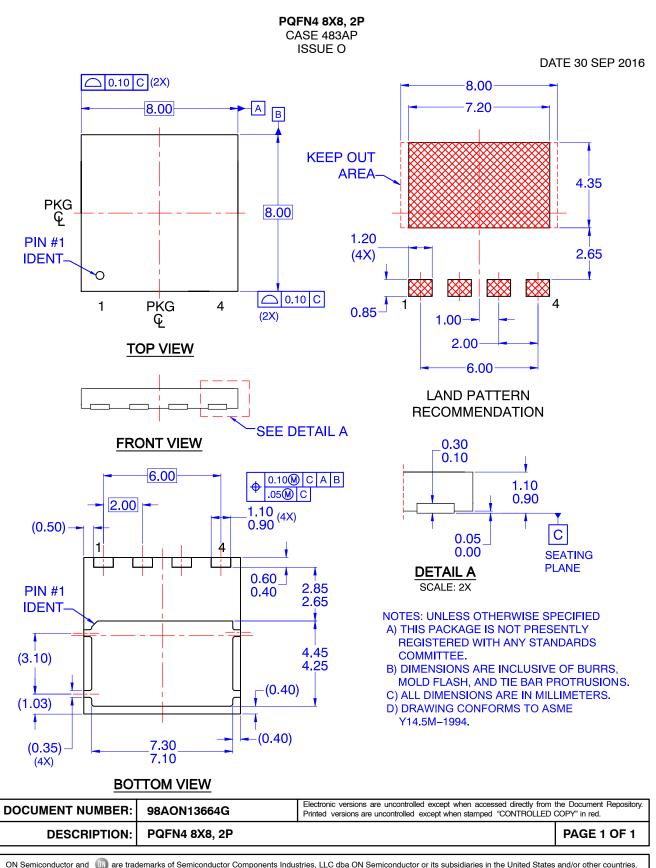


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

SUPERFET is a registered trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.





ON Semiconductor and () are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the right or there.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor date sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use a a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor houteds for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

ON Semiconductor Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910 Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative